



Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	13
Program Memory Size	896B (512 x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	80 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c554-04i-so

Table of Contents

1.0	General Description.....	5
2.0	PIC16C55X Device Varieties	7
3.0	Architectural Overview	9
4.0	Memory Organization	13
5.0	I/O Ports	23
6.0	Special Features of the CPU	31
7.0	Timer0 Module	47
8.0	Instruction Set Summary	53
9.0	Development Support.....	67
10.0	Electrical Specifications.....	73
11.0	Packaging Information.....	87
Appendix A:	Enhancements.....	97
Appendix B:	Compatibility	97
Index		99
On-Line Support.....		101
Systems Information and Upgrade Hot Line		101
Reader Response		102
Product Identification System		103

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at docerrors@mail.microchip.com or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

<http://www.microchip.com>

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; <http://www.microchip.com>
- Your local Microchip sales office (see last page)
- The Microchip Corporate Literature Center; U.S. FAX: (480) 792-7277

When contacting a sales office or the literature center, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com/cn to receive the most current information on all of our products.

PIC16C55X

TABLE 1-1: PIC16C55X FAMILY OF DEVICES

		PIC16C554	PIC16C557	PIC16C558
Clock	Maximum Frequency of Operation (MHz)	20	20	20
Memory	EPROM Program Memory (x14 words)	512	2K	2K
	Data Memory (bytes)	80	128	128
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0
Features	Interrupt Sources	3	3	3
	I/O Pins	13	22	13
	Voltage Range (Volts)	2.5-5.5	2.5-5.5	2.5-5.5
	Brown-out Reset	—	—	—
	Packages	18-pin DIP, SOIC; 20-pin SSOP	28-pin DIP, SOIC; 28-pin SSOP	18-pin DIP, SOIC, SSOP
All PIC [®] Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C55X Family devices use serial programming with clock pin RB6 and data pin RB7.				

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16C55X family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16C55X uses a Harvard architecture in which program and data are accessed from separate memories using separate busses. This improves bandwidth over traditional von Neumann architecture where program and data are fetched from the same memory. Separating program and data memory further allows instructions to be sized differently from 8-bit wide data words. Instruction opcodes are 14-bit wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions (35) execute in a single-cycle (200 ns @ 20 MHz) except for program branches. The table below lists the memory (EPROM and RAM).

Device	Program Memory (EPROM)	Data Memor (RAM)
PIC16C554	512	80
PIC16C557	2 K	128
PIC16C558	2 K	128

The PIC16C554 addresses 512 x 14 on-chip program memory. The PIC16C557 and PIC16C558 addresses 2 K x 14 program memory. All program memory is internal.

The PIC16C55X can directly or indirectly address its register files or data memory. All special function registers, including the program counter, are mapped into the data memory. The PIC16C55X has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any Addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16C55X simple yet efficient. In addition, the learning curve is reduced significantly.

The PIC16C55X devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register). The other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a Borrow and Digit Borrow out bit, respectively, in subtraction. See the `SUBLW` and `SUBWF` instructions for examples.

A simplified block diagram is shown in Figure 3-1, with a description of the device pins in Table 3-1.

TABLE 3-1: PIC16C55X PINOUT DESCRIPTION

Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	SOIC	SSOP			
OSC1/CLKIN	16	16	18	I	ST/CMOS	Oscillator crystal input/external clock source output.
OSC2/CLKOUT	15	15	17	O	—	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/VPP	4	4	4	I/P	ST	Master clear (Reset) input/programming voltage input. This pin is an active low RESET to the device.
RA0	17	17	19	I/O	ST	Bi-directional I/O port
RA1	18	18	20	I/O	ST	Bi-directional I/O port
RA2	1	1	1	I/O	ST	Bi-directional I/O port
RA3	2	2	2	I/O	ST	Bi-directional I/O port
RA4/T0CKI	3	3	3	I/O	ST	Bi-directional I/O port or external clock input for TMR0. Output is open drain type.
RB0/INT	6	6	7	I/O	TTL/ST ⁽¹⁾	Bi-directional I/O port can be software programmed for internal weak pull-up. RB0/INT can also be selected as an external interrupt pin.
RB1	7	7	8	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up.
RB2	8	8	9	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up.
RB3	9	9	10	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up.
RB4	10	10	11	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up. Interrupt-on-change pin.
RB5	11	11	12	I/O	TTL	Bi-directional I/O port can be software programmed for internal weak pull-up. Interrupt-on-change pin.
RB6	12	12	13	I/O	TTL/ST ⁽²⁾	Bi-directional I/O port can be software programmed for internal weak pull-up. Interrupt-on-change pin. Serial programming clock.
RB7	13	13	14	I/O	TTL/ST ⁽²⁾	Bi-directional I/O port can be software programmed for internal weak pull-up. Interrupt-on-change pin. Serial programming data.
RC0 ⁽³⁾	18	18	18	I/O	TTL	Bi-directional I/O port input buffer.
RC1 ⁽³⁾	19	19	19	I/O	TTL	Bi-directional I/O port input buffer.
RC2 ⁽³⁾	20	20	20	I/O	TTL	Bi-directional I/O port input buffer.
RC3 ⁽³⁾	21	21	21	I/O	TTL	Bi-directional I/O port input buffer.
RC4 ⁽³⁾	22	22	22	I/O	TTL	Bi-directional I/O port input buffer.
RC5 ⁽³⁾	23	23	23	I/O	TTL	Bi-directional I/O port input buffer.
RC6 ⁽³⁾	24	24	24	I/O	TTL	Bi-directional I/O port input buffer.
RC7 ⁽³⁾	25	25	25	I/O	TTL	Bi-directional I/O port input buffer.
Vss	5	5	5,6	P	—	Ground reference for logic and I/O pins.
VDD	14	14	15,16	P	—	Positive supply for logic and I/O pins.

Legend: O = Output I/O = Input/output P = Power
 — = Not used I = Input ST = Schmitt Trigger input
 TTL = TTL input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.
 2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.
 3: PIC16C557 only.

PIC16C55X

3.1 Clocking Scheme/Instruction Cycle

The clock input (OSC1/CLKIN pin) is internally divided by four to generate four non-overlapping quadrature clocks namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 3-2.

3.2 Instruction Flow/Pipelining

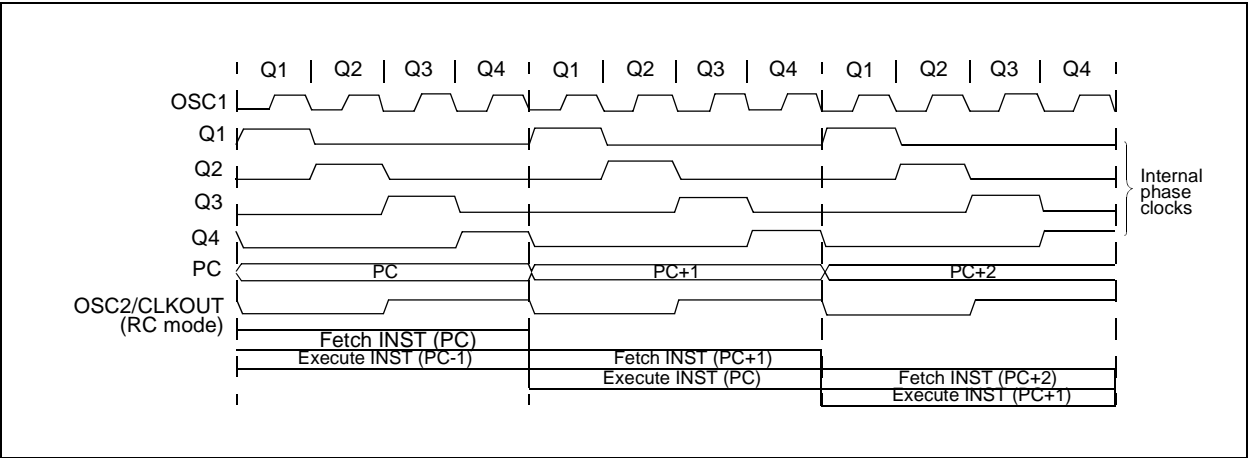
An “Instruction Cycle” consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle

while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g., GOTO), then two cycles are required to complete the instruction (Example 3-1).

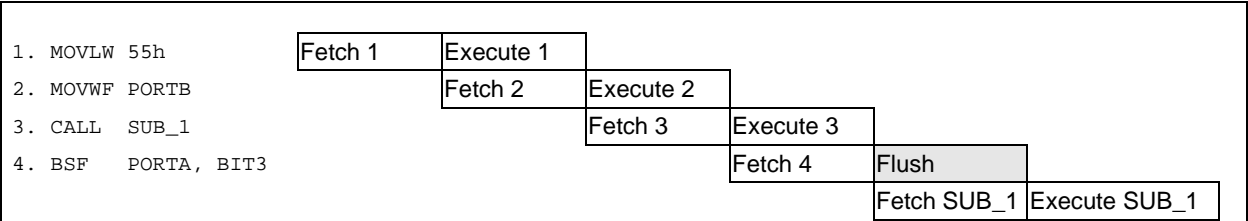
A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the “Instruction Register (IR)” in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 3-2: CLOCK/INSTRUCTION CYCLE



EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW



All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is “flushed” from the pipeline while the new instruction is being fetched and then executed.

6.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real-time applications. The PIC16C55X family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection.

These are:

1. OSC selection
2. RESET
3. Power-on Reset (POR)
4. Power-up Timer (PWRT)
5. Oscillator Start-Up Timer (OST)
6. Interrupts
7. Watchdog Timer (WDT)
8. SLEEP
9. Code protection
10. ID Locations
11. In-circuit serial programming™

The PIC16C55X has a Watchdog Timer which is controlled by configuration bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), which is intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only, designed to keep the part in RESET while the power supply stabilizes. With these two functions on-chip, most applications need no external RESET circuitry.

The SLEEP mode is designed to offer a very low current Power-down mode. The user can wake-up from SLEEP through external RESET, Watchdog Timer wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

6.1 Configuration Bits

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h – 3FFFh), which can be accessed only during programming.

PIC16C55X

TABLE 6-5: INITIALIZATION CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	---- --0-
MCLR Reset during normal operation	000h	000u uuuu	---- --u-
MCLR Reset during SLEEP	000h	0001 0uuu	---- --u-
WDT Reset	000h	0000 uuuu	---- --u-
WDT Wake-up	PC + 1	uuu0 0uuu	---- --u-
Interrupt Wake-up from SLEEP	PC + 1 ⁽¹⁾	uuu1 0uuu	---- --u-

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: When the wake-up is due to an interrupt and global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

TABLE 6-6: INITIALIZATION CONDITION FOR REGISTERS

Register	Address	Power-on Reset	MCLR Reset during normal operation MCLR Reset during SLEEP WDT Reset	Wake-up from SLEEP through interrupt Wake-up from SLEEP through WDT timeout
W	—	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	00h	—	—	—
TMR0	01h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	02h	0000 0000	0000 0000	PC + 1 ⁽²⁾
STATUS	03h	0001 1xxx	000q quuu ⁽³⁾	uuuq quuu ⁽³⁾
FSR	04h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	05h	---x xxxx	---u uuuu	---u uuuu
PORTB	06h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTC ⁽⁴⁾	06h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCLATH	0Ah	---0 0000	---0 0000	---u uuuu
INTCON	0Bh	0000 000x	0000 000u	uuuu uuuu ⁽¹⁾
OPTION	81h	1111 1111	1111 1111	uuuu uuuu
TRISA	85h	---1 1111	---1 1111	---u uuuu
TRISB	86h	1111 1111	1111 1111	uuuu uuuu
TRISC ⁽⁴⁾	86h	1111 1111	1111 1111	uuuu uuuu
PCON	8Eh	---- --0-	---- --u-	---- --u-

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: One or more bits in INTCON will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 6-5 for RESET value for specific condition.

4: PIC16C557 only.

PIC16C55X

FIGURE 6-9: TIMEOUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ TIED TO V_{DD}): CASE 3

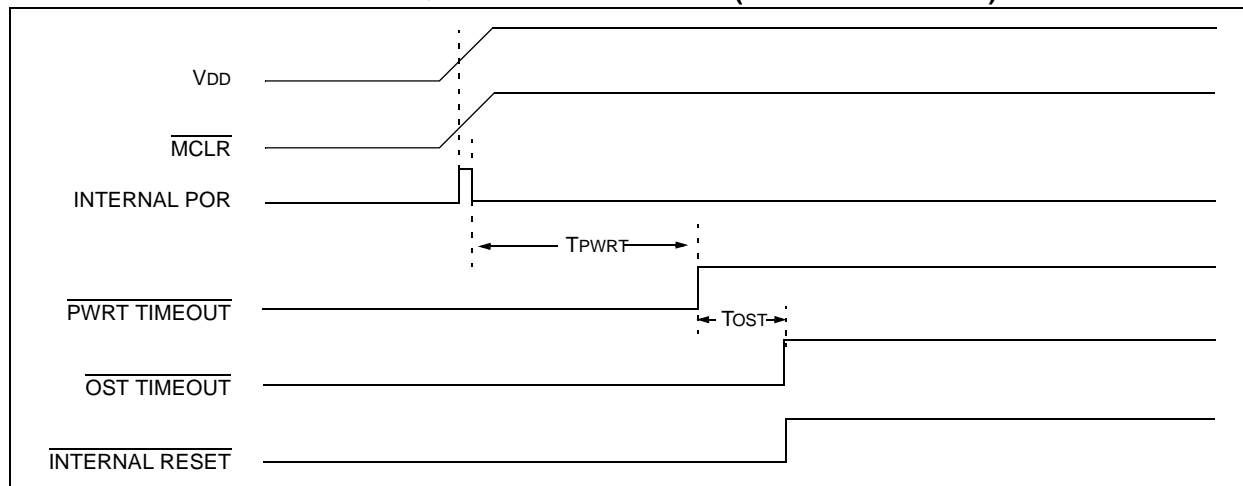
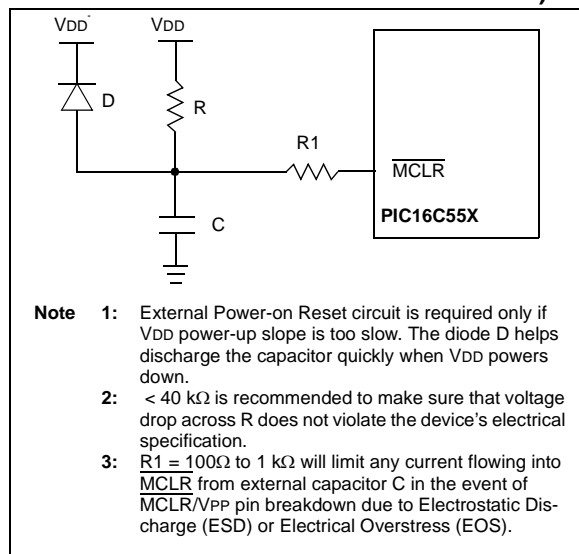


FIGURE 6-10: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW V_{DD} POWER-UP)



PIC16C55X

6.5.1 RB0/INT INTERRUPT

An external interrupt on RB0/INT pin is edge triggered: either rising if INTEDG bit (OPTION<6>) is set, or falling if INTEDG bit is clear. When a valid edge appears on the RB0/INT pin, the INTF bit (INTCON<1>) is set. This interrupt can be disabled by clearing the INTE control bit (INTCON<4>). The INTF bit must be cleared in software in the interrupt service routine before re-enabling this interrupt. The RB0/INT interrupt can wake-up the processor from SLEEP, if the INTE bit was set prior to going into SLEEP. The status of the GIE bit decides whether or not the processor branches to the interrupt vector following wake-up. See Section 6.8 for details on SLEEP and Figure 6-14 for timing of wake-up from SLEEP through RB0/INT interrupt.

6.5.2 TMR0 INTERRUPT

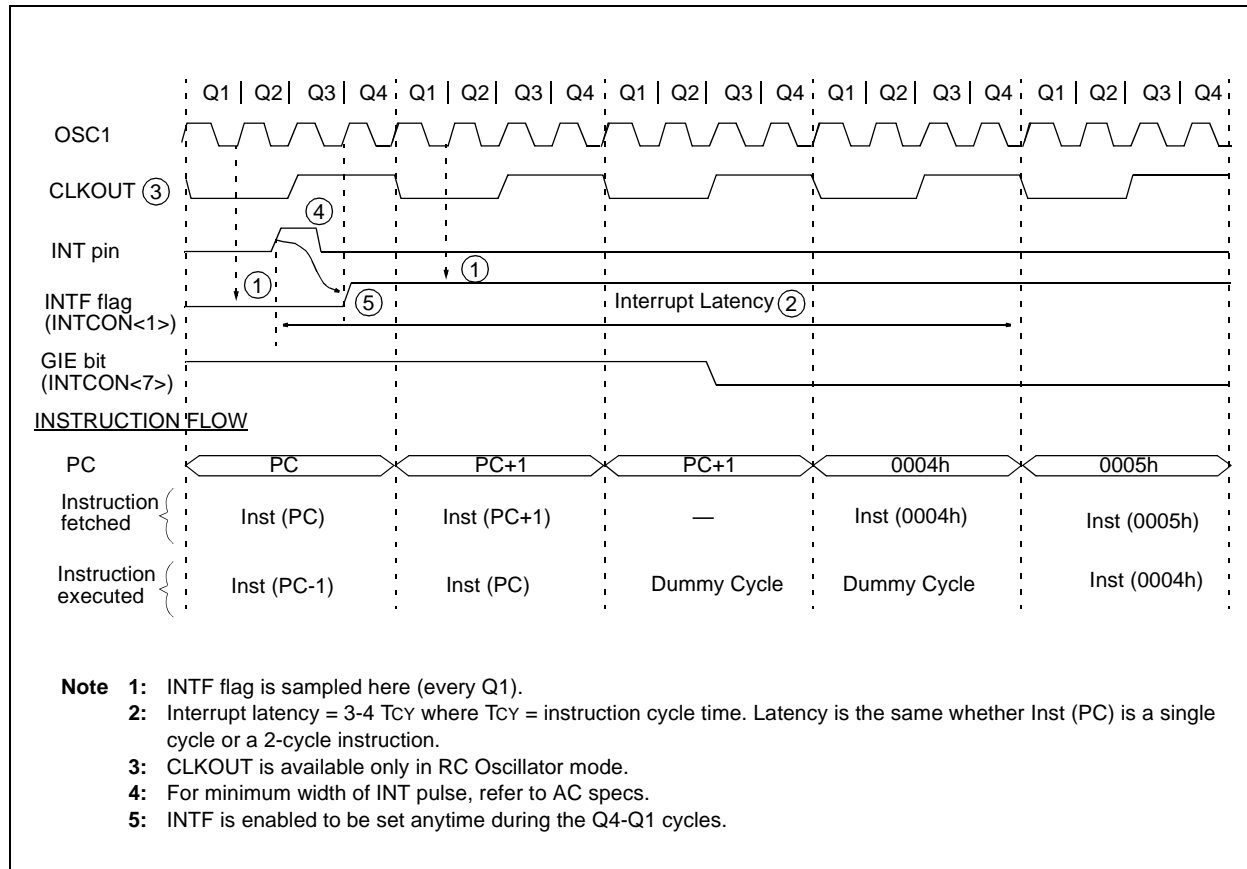
An overflow (FFh → 00h) in the TMR0 register will set the T0IF (INTCON<2>) bit. The interrupt can be enabled/disabled by setting/clearing T0IE (INTCON<5>) bit. For operation of the Timer0 module, see Section 7.0.

6.5.3 PORTB INTERRUPT

An input change on PORTB <7:4> sets the RBIF (INTCON<0>) bit. The interrupt can be enabled/disabled by setting/clearing the RBIE (INTCON<4>) bit. For operation of PORTB (Section 5.2).

Note: If a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then the RBIF interrupt flag may get set.

FIGURE 6-12: INT PIN INTERRUPT TIMING



8.1 Instruction Descriptions

ADDLW Add Literal and W

Syntax:	[<i>label</i>] ADDLW k				
Operands:	$0 \leq k \leq 255$				
Operation:	$(W) + k \rightarrow (W)$				
Status Affected:	C, DC, Z				
Encoding:	<table border="1"><tr><td>11</td><td>111x</td><td>kkkk</td><td>kkkk</td></tr></table>	11	111x	kkkk	kkkk
11	111x	kkkk	kkkk		
Description:	The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.				
Words:	1				
Cycles:	1				
Example	ADDLW 0x15 Before Instruction W = 0x10 After Instruction W = 0x25				

ANDLW AND Literal with W

Syntax:	[<i>label</i>] ANDLW k				
Operands:	0 ≤ k ≤ 255				
Operation:	(W) .AND. (k) → (W)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>11</td><td>1001</td><td>kkkk</td><td>kkkk</td></tr></table>	11	1001	kkkk	kkkk
11	1001	kkkk	kkkk		
Description:	The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.				
Words:	1				
Cycles:	1				
Example	ANDLW 0x5F Before Instruction W = 0xA3 After Instruction W = 0x03				

ADDWF Add W and f

Syntax:	[<i>label</i>] ADDWF <i>f,d</i>												
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$												
Operation:	$(W) + (f) \rightarrow (\text{dest})$												
Status Affected:	C, DC, Z												
Encoding:	<table><tr><td>00</td><td>0111</td><td>dfff</td><td>ffff</td></tr></table>	00	0111	dfff	ffff								
00	0111	dfff	ffff										
Description:	Add the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.												
Words:	1												
Cycles:	1												
Example	<pre>ADDWF FSR, 0</pre> <p>Before Instruction</p> <table><tr><td>W</td><td>=</td><td>0x17</td></tr><tr><td>FSR</td><td>=</td><td>0xC2</td></tr></table> <p>After Instruction</p> <table><tr><td>W</td><td>=</td><td>0xD9</td></tr><tr><td>FSR</td><td>=</td><td>0xC2</td></tr></table>	W	=	0x17	FSR	=	0xC2	W	=	0xD9	FSR	=	0xC2
W	=	0x17											
FSR	=	0xC2											
W	=	0xD9											
FSR	=	0xC2											

ANDWF AND W with f

Syntax:	[<i>label</i>] ANDWF <i>f,d</i>				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	(W) .AND. (f) \rightarrow (dest)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>00</td><td>0101</td><td>dfff</td><td>ffff</td></tr></table>	00	0101	dfff	ffff
00	0101	dfff	ffff		
Description:	AND the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Example	ANDWF FSR, 1 Before Instruction W = 0x17 FSR = 0xC2 After Instruction W = 0x17 FSR = 0x02				

PIC16C55X

CLR W	Clear W				
Syntax:	[<i>label</i>] CLRW				
Operands:	None				
Operation:	00h → (W) 1 → Z				
Status Affected:	Z				
Encoding:	<table><tr><td>00</td><td>0001</td><td>0000</td><td>0011</td></tr></table>	00	0001	0000	0011
00	0001	0000	0011		
Description:	W register is cleared. Zero bit (Z) is set.				
Words:	1				
Cycles:	1				
Example	CLRW Before Instruction W = 0x5A After Instruction W = 0x00 Z = 1				

COMF	Complement f				
Syntax:	[<i>label</i>] COMF f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	$(\bar{f}) \rightarrow (\text{dest})$				
Status Affected:	Z				
Encoding:	<table><tr><td>00</td><td>1001</td><td>dfff</td><td>ffff</td></tr></table>	00	1001	dfff	ffff
00	1001	dfff	ffff		
Description:	The contents of register 'f' are complemented. If 'd' is 0 the result is stored in W. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Example	COMF REG1,0 Before Instruction REG1 = 0x13 After Instruction REG1 = 0x13 W = 0xEC				

CLRWD T	Clear Watchdog Timer				
Syntax:	[<i>label</i>] CLRWD T				
Operands:	None				
Operation:	00h → WDT 0 → WDT prescaler, 1 → \overline{TO} 1 → \overline{PD}				
Status Affected:	\overline{TO} , \overline{PD}				
Encoding:	<table><tr><td>00</td><td>0000</td><td>0110</td><td>0100</td></tr></table>	00	0000	0110	0100
00	0000	0110	0100		
Description:	CLRWD T instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits \overline{TO} and \overline{PD} are set.				
Words:	1				
Cycles:	1				
Example	<div>CLRWD T</div> <div>Before Instruction</div> <div>WDT counter = ?</div> <div>After Instruction</div> <div>WDT counter = 0x00</div> <div>WDT prescaler = 0</div> <div>\overline{TO} = 1</div> <div>\overline{PD} = 1</div>				

DECF	Decrement f				
Syntax:	[<i>label</i>] DECF f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	$(f) - 1 \rightarrow (\text{dest})$				
Status Affected:	Z				
Encoding:	<table><tr><td>00</td><td>0011</td><td>dfff</td><td>ffff</td></tr></table>	00	0011	dfff	ffff
00	0011	dfff	ffff		
Description:	Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Example	DECF CNT, 1 Before Instruction CNT = 0x01 Z = 0 After Instruction CNT = 0x00 Z = 1				

PIC16C55X

RETFIE		Return from Interrupt							
Syntax:	[<i>label</i>] RETFIE								
Operands:	None								
Operation:	TOS → PC, 1 → GIE								
Status Affected:	None								
Encoding:	<table border="1"><tr><td>00</td><td>0000</td><td>0000</td><td>1001</td></tr></table>				00	0000	0000	1001	
00	0000	0000	1001						
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two-cycle instruction.								
Words:	1								
Cycles:	2								
Example	RETFIE								
	After Interrupt								
	PC = TOS								
	GIE = 1								

RETURN		Return from Subroutine								
Syntax:	[<i>label</i>] RETURN									
Operands:	None									
Operation:	TOS → PC									
Status Affected:	None									
Encoding:	<table border="1"><tr><td>00</td><td>0000</td><td>0000</td><td>1000</td></tr></table>						00	0000	0000	1000
00	0000	0000	1000							
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two-cycle instruction.									
Words:	1									
Cycles:	2									
Example	RETURN									
	After Interrupt									
	PC = TOS									

RETLW		Return with Literal in W							
Syntax:	[<i>label</i>] RETLW <i>k</i>								
Operands:	$0 \leq k \leq 255$								
Operation:	$k \rightarrow (W);$ TOS \rightarrow PC								
Status Affected:	None								
Encoding:	<table><tr><td>11</td><td>01xx</td><td>kkkk</td><td>kkkk</td></tr></table>					11	01xx	kkkk	kkkk
11	01xx	kkkk	kkkk						
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.								
Words:	1								
Cycles:	2								
Example	<pre>CALL TABLE;W contains table ;offset value ;W now has table value . . . ADDWF PC ;W = offset TABLE RETLW k1 ;Begin table RETLW k2 ; . . RETLW kn ; End of table</pre> <p>Before Instruction</p> <p>W = 0x07</p> <p>After Instruction</p> <p>W = value of k8</p>								

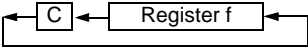
RLF	Rotate Left f through Carry				
Syntax:	[<i>label</i>] RLF <i>f</i> , <i>d</i>				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	See description below				
Status Affected:	C				
Encoding:	<table><tr><td>00</td><td>1101</td><td>dfff</td><td>ffff</td></tr></table>	00	1101	dfff	ffff
00	1101	dfff	ffff		
Description:	<p>The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is stored back in register 'f'.</p> 				
Words:	1				
Cycles:	1				
Example	<pre>RLF REG1,0</pre> <p>Before Instruction</p> <pre>REG1 = 1110 0110 C = 0</pre> <p>After Instruction</p> <pre>REG1 = 1110 0110 W = 1100 1100 C = 1</pre>				

FIGURE 10-3: VOLTAGE-FREQUENCY GRAPH, $0^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$

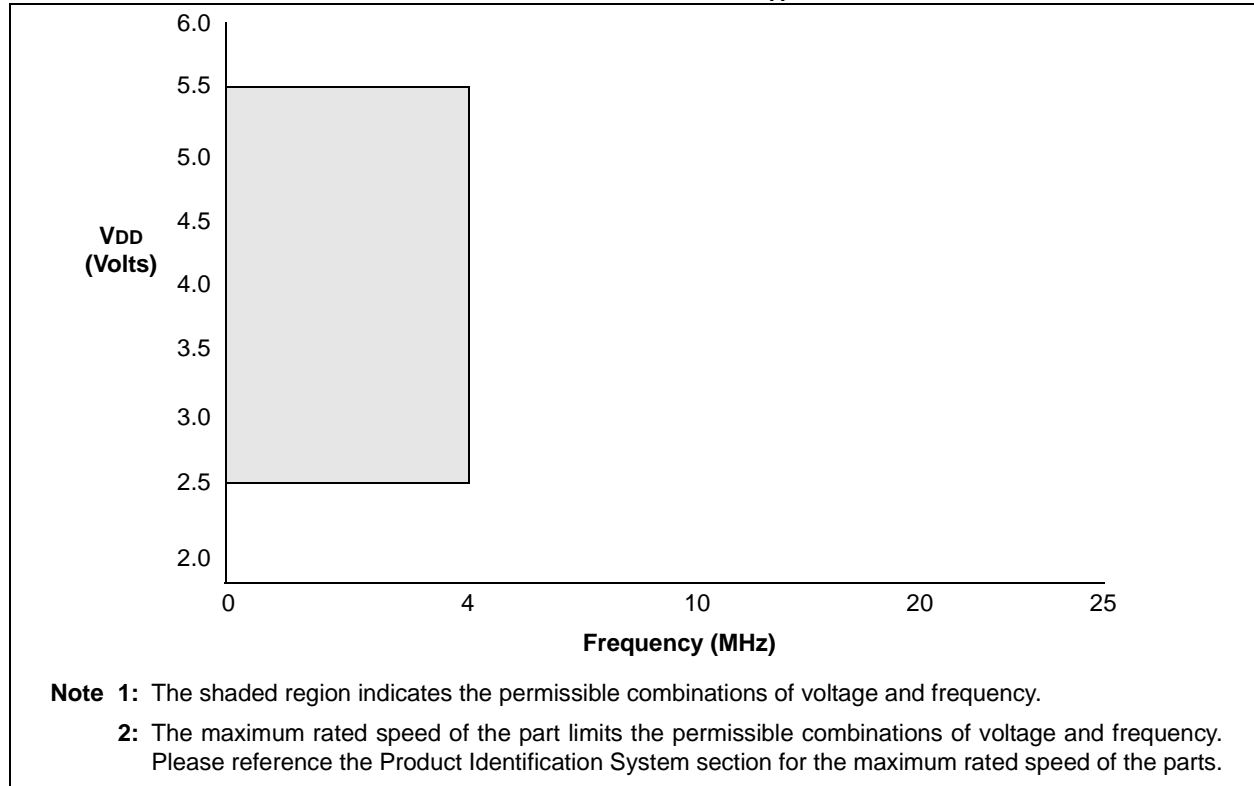
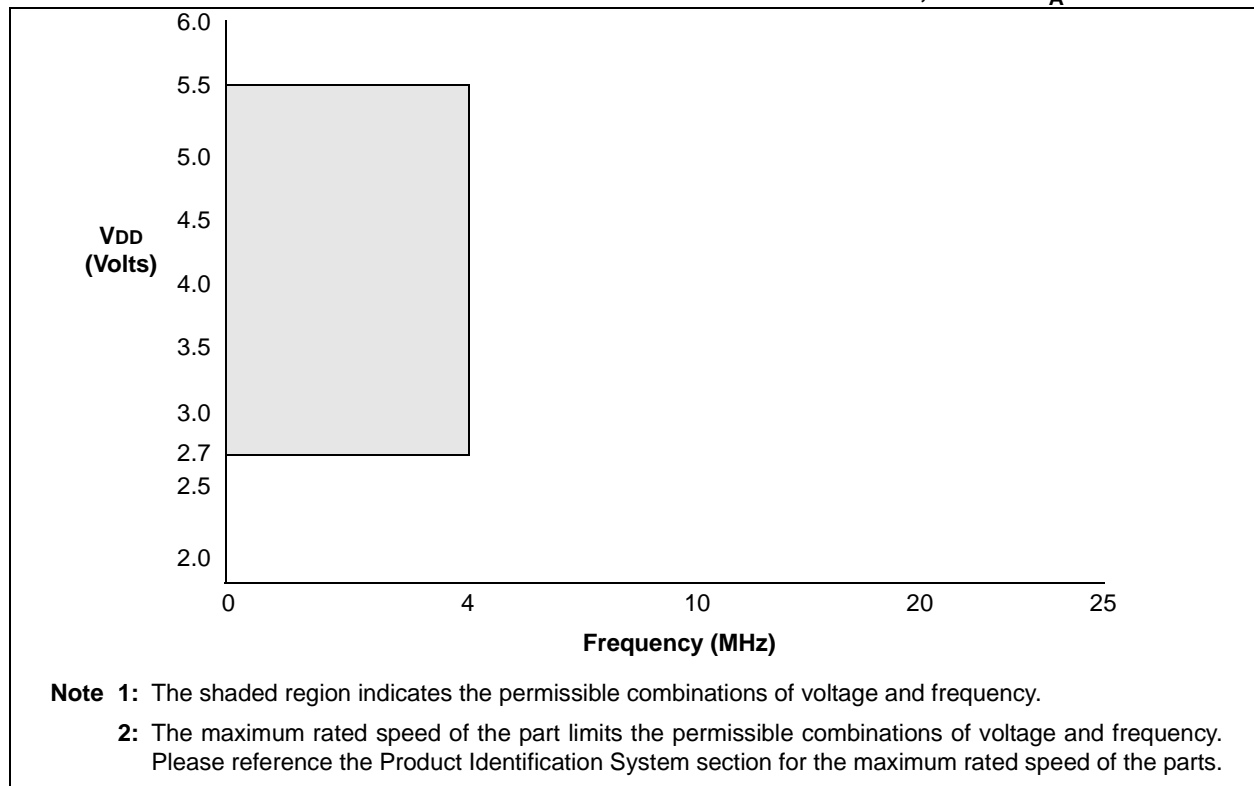


FIGURE 10-4: PIC16LC554/557/558 VOLTAGE-FREQUENCY GRAPH, $-40^{\circ}\text{C} \leq T_A \leq 0^{\circ}\text{C}$



PIC16C55X

10.1 DC Characteristics: PIC16C55X-04 (Commercial, Industrial, Extended) PIC16C55X-20 (Commercial, Industrial, Extended) HCS1365-04 (Commercial, Industrial, Extended)

DC Characteristics		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended					
Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D001	V _{DD}	Supply Voltage					
		16LC55X	3.0 2.5	—	5.5 5.5	V	XT and RC osc configuration LP osc configuration
D001 D001A		16C55X	3.0 4.5	— —	5.5 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002	V _{DR}	RAM Data Retention Voltage⁽¹⁾	—	1.5*	—	V	Device in SLEEP mode
D003	V _{POR}	V_{DD} Start Voltage to ensure Power-on Reset	—	V _{SS}	—	V	See Section 6.4, Power-on Reset for details
D004	S _{VDD}	V_{DD} Rise Rate to ensure Power-on Reset	0.05*	—	—	V/ms	See Section 6.4, Power-on Reset for details
D010 D010A D010 D010A D013	I _{DD}	Supply Current⁽²⁾					
		16LC55X	—	1.4	2.5	mA	XT and RC osc configuration Fosc = 2.0 MHz, V _{DD} = 3.0V, WDT disabled ⁽⁴⁾
			—	26	53	μA	LP osc configuration Fosc = 32 kHz, V _{DD} = 3.0V, WDT disabled
		16C55X	—	1.8	3.3	mA	XT and RC osc configuration Fosc = 4 MHz, V _{DD} = 5.5V, WDT disabled ⁽⁴⁾
			—	35	70	μA	LP osc configuration, PIC16C55X-04 only Fosc = 32 kHz, V _{DD} = 4.0V, WDT disabled
			—	9.0	20	mA	HS osc configuration Fosc = 20 MHz, V _{DD} = 5.5V, WDT disabled

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which V_{DD} can be lowered in SLEEP mode without losing RAM data.

Note 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all I_{DD} measurements in active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins configured as input, pulled to V_{DD},

MCLR = V_{DD}; WDT enabled/disabled as specified.

Note 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins configured as input and tied to V_{DD} or V_{SS}.

Note 4: For RC osc configuration, current through R_{EXT} is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{EXT}$ (mA) with R_{EXT} in kΩ.

Note 5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base I_{DD} or I_{PD} measurement.

10.1 DC Characteristics: PIC16C55X-04 (Commercial, Industrial, Extended) PIC16C55X-20 (Commercial, Industrial, Extended) HCS1365-04 (Commercial, Industrial, Extended)

DC Characteristics		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial and -40°C ≤ TA ≤ +125°C for extended					
Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D020	IPD	Power-Down Current⁽³⁾					
		16LC55X	—	0.7	2	μA	VDD = 3.0V, WDT disabled
		16C55X	—	1.0	2.5	μA	VDD = 4.0V, WDT disabled
	ΔI _{WDT}	WDT Current⁽⁵⁾					
		16LC55X	—	6.0	15	μA	VDD = 3.0V
		16C55X	—	6.0	20	μA	VDD = 4.0V (+85°C to +125°C)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins configured as input, pulled to VDD,

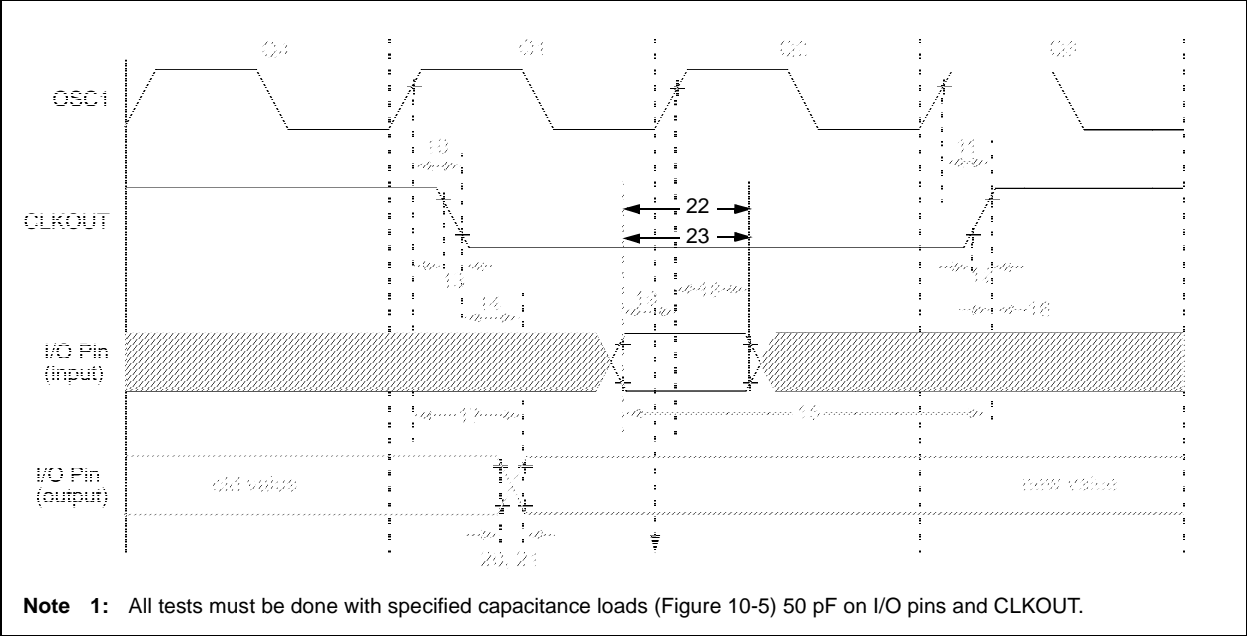
MCLR = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins configured as input and tied to VDD or VSS.

4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{EXT}$ (mA) with REXT in kΩ.

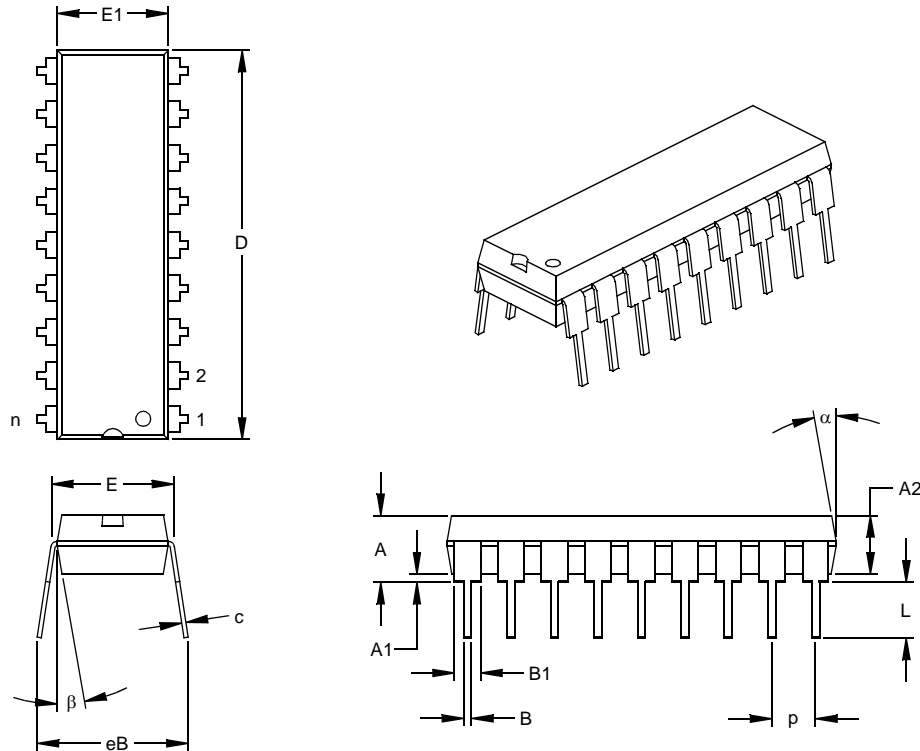
5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

FIGURE 10-7: CLKOUT AND I/O TIMING



18-Lead Plastic Dual In-line (P) – 300 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.155	.170	3.56	3.94	4.32
Molded Package Thickness	A2	.115	.130	.145	2.92	3.30	3.68
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.240	.250	.260	6.10	6.35	6.60
Overall Length	D	.890	.898	.905	22.61	22.80	22.99
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.058	.070	1.14	1.46	1.78
Lower Lead Width	B	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing	§ eB	.310	.370	.430	7.87	9.40	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter

§ Significant Characteristic

Notes:

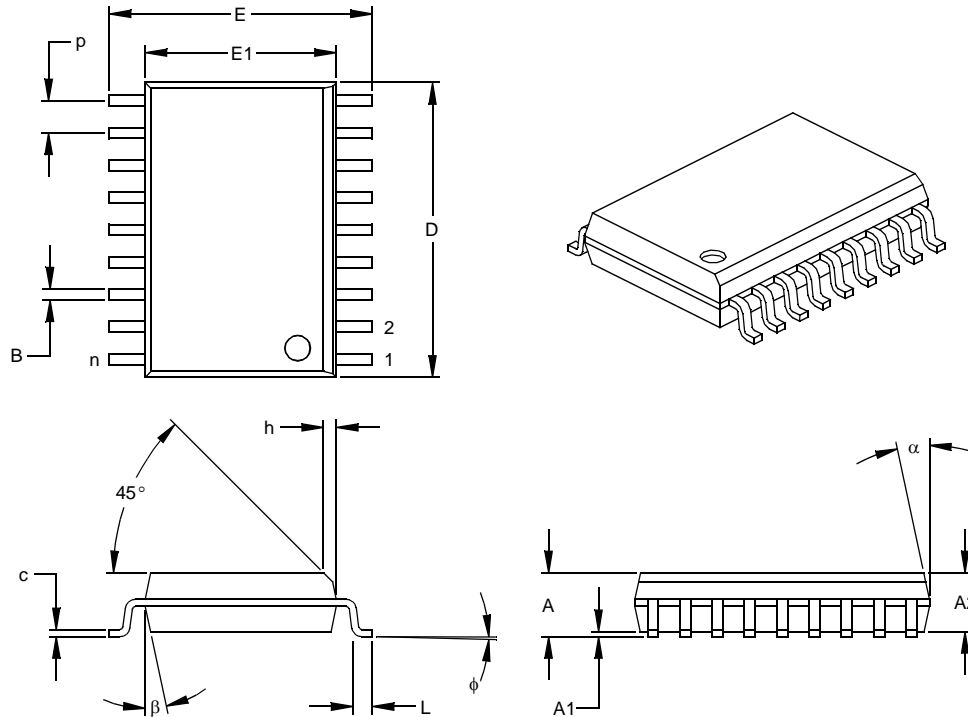
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-001

Drawing No. C04-007

18-Lead Plastic Small Outline (SO) – Wide, 300 mil (SOIC)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	P		.050			1.27	
Overall Height	A	.093	.099	.104	2.36	2.50	2.64
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30
Overall Width	E	.394	.407	.420	10.01	10.34	10.67
Molded Package Width	E1	.291	.295	.299	7.39	7.49	7.59
Overall Length	D	.446	.454	.462	11.33	11.53	11.73
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74
Foot Length	L	.016	.033	.050	0.41	0.84	1.27
Foot Angle	φ	0	4	8	0	4	8
Lead Thickness	c	.009	.011	.012	0.23	0.27	0.30
Lead Width	B	.014	.017	.020	0.36	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-013

Drawing No. C04-051

APPENDIX A: ENHANCEMENTS

The following are the list of enhancements over the PIC16C5X microcontroller family:

1. Instruction word length is increased to 14 bits. This allows larger page sizes both in program memory (4K now as opposed to 512 before) and register file (up to 128 bytes now versus 32 bytes before).
2. A PC high latch register (PCLATH) is added to handle program memory paging. PA2, PA1, PA0 bits are removed from STATUS register.
3. Data memory paging is slightly redefined. STATUS register is modified.
4. Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW. Two instructions TRIS and OPTION are being phased out although they are kept for compatibility with PIC16C5X.
5. OPTION and TRIS registers are made addressable.
6. Interrupt capability is added. Interrupt vector is at 0004h.
7. Stack size is increased to 8 deep.
8. RESET vector is changed to 0000h.
9. RESET of all registers is revised. Three different RESET (and wake-up) types are recognized. Registers are reset differently.
10. Wake-up from SLEEP through interrupt is added.
11. Two separate timers, Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
12. PORTB has weak pull-ups and interrupt-on-change feature.
13. Timer0 clock input, T0CKI pin is also a port pin (RA4/T0CKI) and has a TRIS bit.
14. FSR is made a full 8-bit register.
15. "In-circuit programming" is made possible. The user can program PIC16C55X devices using only five pins: VDD, VSS, VPP, RB6 (clock) and RB7 (data in/out).
16. PCON status register is added with a Power-on Reset (POR) status bit.
17. Code protection scheme is enhanced such that portions of the program memory can be protected, while the remainder is unprotected.
18. PORTA inputs are now Schmitt Trigger inputs.

APPENDIX B: COMPATIBILITY

To convert code written for PIC16C5X to PIC16C55X, the user should take the following steps:

1. Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
3. Eliminate any data memory page switching. Redefine data variables to reallocate them.
4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
5. Change RESET vector to 0000h.

APPENDIX C: REVISION HISTORY

Revision E (January 2013)

Added a note to each package outline drawing.

INDEX

A

ADDLW Instruction	55
ADDWF Instruction	55
ANDLW Instruction	55
ANDWF Instruction	55
Architectural Overview	9
Assembler	
MPASM Assembler	67

B

BCF Instruction	56
Block Diagram	
TIMER0	47
TMR0/WDT PRESCALER	50
BSF Instruction	56
BTFSC Instruction	56
BTFSS Instruction	57

C

CALL Instruction	57
Clocking Scheme/Instruction Cycle	12
CLRF Instruction	57
CLRW Instruction	58
CLRWDW Instruction	58
Code Protection	46
COMF Instruction	58
Configuration Bits	31

D

Data Memory Organization	13
DECF Instruction	58
DECFSZ Instruction	59
Development Support	67

E

Errata	3
External Crystal Oscillator Circuit	34

G

General purpose Register File	13
GOTO Instruction	59

I

I/O Ports	23
I/O Programming Considerations	28
ICEPIC In-Circuit Emulator	68
ID Locations	46
INCF Instruction	59
INCFSSZ Instruction	60
In-Circuit Serial Programming	46
Indirect Addressing, INDF and FSR Registers	21
Instruction Flow/Pipelining	12
Instruction Set	
ADDLW	55
ADDWF	55
ANDLW	55
ANDWF	55
BCF	56
BSF	56
BTFSC	56
BTFSS	57
CALL	57
CLRF	57

CLRW	58
CLRWDW	58
COMF	58
DECF	58
DECFSZ	59
GOTO	59
INCF	59
INCFSSZ	60
IORLW	60
IORWF	60
MOVF	61
MOVLW	60
MOVWF	61
NOP	61
OPTION	61
RETFIE	62
RETLW	62
RETURN	62
RLF	62
RRF	63
SLEEP	63
SUBLW	63
SUBWF	64
SWAPF	64
TRIS	64
XORLW	65
XORWF	65
Instruction Set Summary	53
INT Interrupt	42
INTCON Register	19
Interrupts	41
IORLW Instruction	60
IORWF Instruction	60

K

KEELOQ Evaluation and Programming Tools	70
---	----

M

MOVF Instruction	61
MOVLW Instruction	60
MOVWF Instruction	61
MPLAB C17 and MPLAB C18 C Compilers	67
MPLAB ICD In-Circuit Debugger	69
MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE	68
MPLAB Integrated Development Environment Software	67
MPLINK Object Linker/MPLIB Object Librarian	68

N

NOP Instruction	61
-----------------------	----

O

One-Time-Programmable (OTP) Devices	7
OPTION Instruction	61
OPTION Register	18
Oscillator Configurations	33
Oscillator Start-up Timer (OST)	36

P

PCL and PCLATH	21
PCON Register	20
PICDEM 1 Low Cost PIC MCU Demonstration Board	69
PICDEM 17 Demonstration Board	70
PICDEM 2 Low Cost PIC16CXX Demonstration Board	69
PICDEM 3 Low Cost PIC16CXXX Demonstration Board	70